

REAL TIME CLOCK MODULE (I²C-Bus)

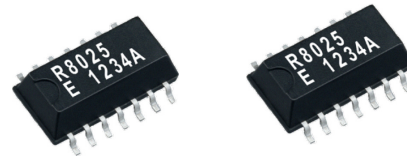
High-Stability



Product Number
RX-8025SA AA : Q41802552000100
RX-8025SA AC : Q41802551000200

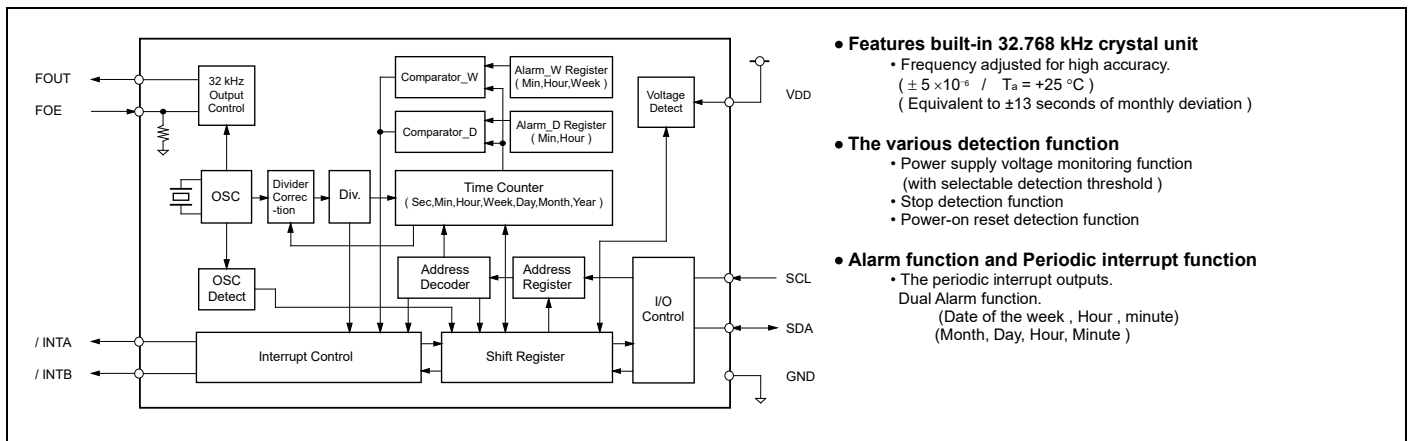
RX-8025SA

- Built-in 32.768 kHz crystal unit : Frequency adjusted for high accuracy ($\pm 5 \times 10^{-6}$ / $T_a = +25^\circ\text{C}$)
- Interface Type : I²C-Bus Interface (400 kHz)
- Operating voltage range : 1.70 V to 5.5 V
- Wide voltage for timekeeping : 1.15 V to 5.5 V
- Various detection Functions : Ex. Oscillation stop detection function
- Low backup current : 0.48 μA / 3 V (Typ.)
- 32.768 kHz frequency output function : C-MOS output with OE pin.
- The various functions include full calendar, Dual alarm, Periodic interruption.



Block diagram

Overview

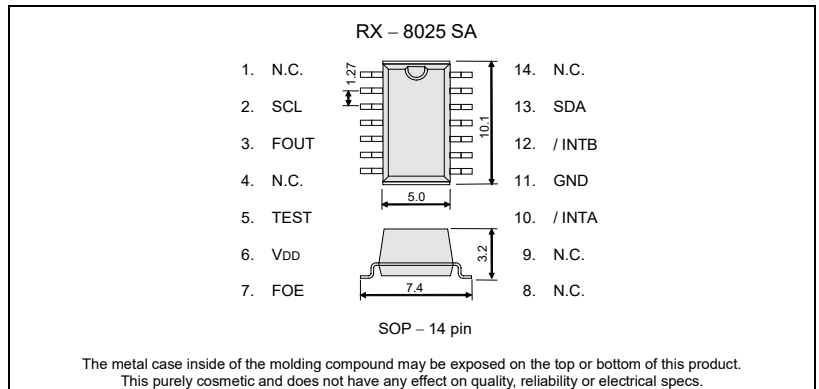


Pin Function

Terminal connection / External dimensions

(Unit:mm)

Signal Name	Input / output	Function																					
SCL	Input	Serial clock input pin																					
SDA	Bi-directional	Data input and output pin																					
FOUT	Output	32.768 kHz clock output pin with the output control function. (C-MOS)																					
FOE	Input	<table><tr><th>FOE input</th><th>/CLEN1 bit</th><th>/CLEN2 bit</th><th>FOUT output</th></tr><tr><td>L</td><td>X</td><td>X</td><td>OFF (LOW)</td></tr><tr><td rowspan="4">H</td><td>0</td><td>0</td><td>32.768 kHz</td></tr><tr><td>0</td><td>1</td><td>32.768 kHz</td></tr><tr><td>1</td><td>0</td><td>32.768 kHz</td></tr><tr><td>1</td><td>1</td><td>OFF(LOW)</td></tr></table>	FOE input	/CLEN1 bit	/CLEN2 bit	FOUT output	L	X	X	OFF (LOW)	H	0	0	32.768 kHz	0	1	32.768 kHz	1	0	32.768 kHz	1	1	OFF(LOW)
FOE input	/CLEN1 bit	/CLEN2 bit	FOUT output																				
L	X	X	OFF (LOW)																				
H	0	0	32.768 kHz																				
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/ INTA	Output	Interrupt output A pin (N-ch open drain)																					
/ INTB	Output	Interrupt output B pin (N-ch open drain)																					
TEST	—	* Used by the manufacture for testing. (Do not connect externally.)																					
VDD	—	Connected to a positive power supply.																					
GND	—	Connected to a ground.																					



Specifications (characteristics)

* Refer to application manual for details.

Recommended Operating Conditions

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Power voltage	VDD	—	1.7	3.0	5.5	V
Clock voltage	VCLK	—	1.15	3.0	5.5	V
Operating temperature	TOPR	—	-40	+25	+85	°C

Frequency characteristics

Item	Symbol	Conditions	Range	Unit
Frequency tolerance	$\Delta f / f$	$T_a = +25^\circ\text{C}$ VDD = 3.0 V	AA: 5 ± 5 ^{*1)} AC: 0 ± 5 ^{*2)}	$\times 10^{-6}$
Oscillation start-up time	t _{STA}	$T_a = +25^\circ\text{C}$ VDD = 2.0 V	1 Max.	s
Frequency voltage characteristics	f / V	$T_a = +25^\circ\text{C}$ VDD = 2.0 V to 5.5 V	± 1 Max.	$\times 10^{-6}$

*1) *2) Equivalent to ± 13 seconds of monthly deviation (excluding offset).

Current consumption characteristics

$T_a = -40^\circ\text{C}$ to $+85^\circ\text{C}$





Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Current Consumption	I _{BK}	f _{SCL} = 0Hz FOE = GND FOUT ; output OFF(LOW)	VDD = 5 V	-	0.60	1.80 μA
	I _{32k}	f _{SCL} = 0Hz VDD, FOE = 5.5 V FOUT ; output ON (Output=OPEN; CL = 0 pF)	VDD = 5.5 V	-	3.0	6.5 μA

Power supply detection voltage

$T_a = -30^\circ\text{C}$ to $+70^\circ\text{C}$

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
High-voltage mode	VDETH	VDD pin	1.90	2.10	2.30	V
Low-voltage mode	VDETL	VDD pin	1.15	1.30	1.45	V

► Explanation of the mark that are using it for the catalog

	► Pb free.
	► Complies with EU RoHS directive. *About the products without the Pb-free mark. Contains Pb in products exempted by EU RoHS directive. (Contains Pb in sealing glass, high melting temperature type solder or other.)
	► Designed for automotive general equipment.
	► Designed for automotive applications related to driving and safety.

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